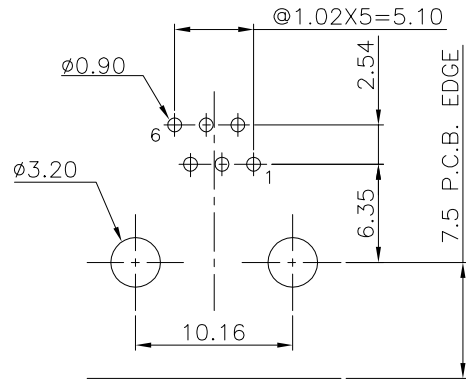
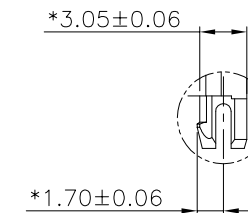
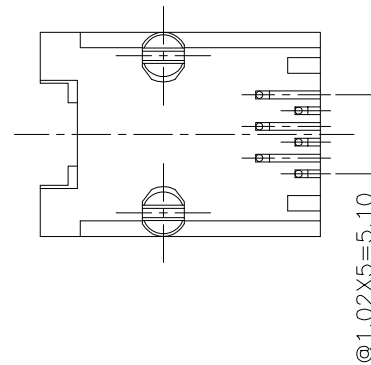
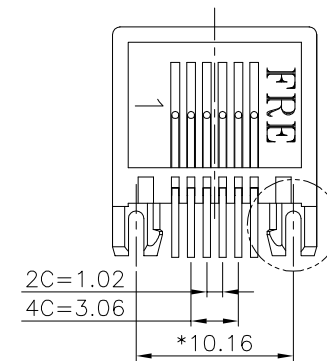
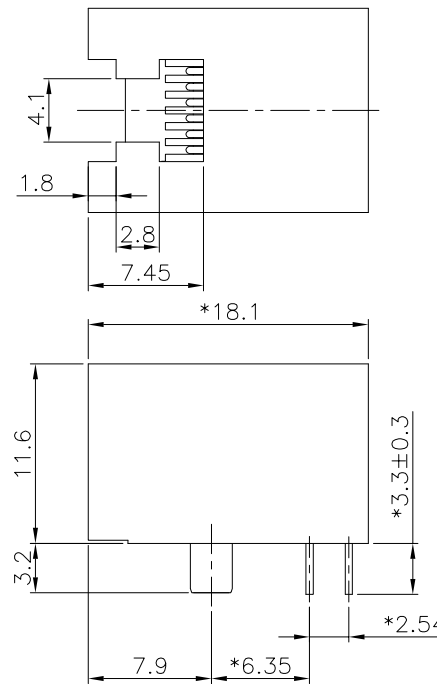
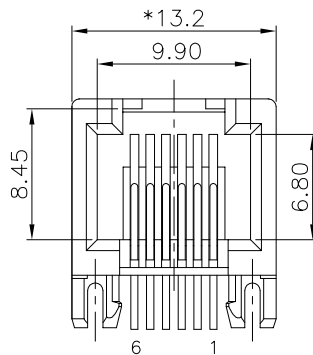


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD



PC Board Layout t=1.60mm
Component Side Shown



NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 150 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 20 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : NYLON+30%G.F UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE Ø0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: -20°C TO 85°C.
3. WAVE SOLDER TEMPERATURE: 255-265°C(5-10 SECOND)

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191

ROHS PART NUMBER: E536X-300XGX-L

- | | | | |
|-------|---------|---------|---------|
| 2- 2C | 1- 3u" | 2- 6u" | 3- 15u" |
| 4- 4C | 4- 30u" | 5- 50u" | |
| 6- 6C | | | |
- MATERIAL OF HS'G :
4-FR50 BK
5-FR52 BK

← MM (INCH) →		DFTO BASS	DATE 8/28/98
TOLERANCES EXCEPT AS NOTED		CHKD QIANPU	DATE 2005/3/17
		MFO	DATE
		APPVLLUSHENG	DATE 2005/3/17
MM		MATERIAL :	
.0 ± 0.2	±	QT'Y :	
.00 ± 0.15	±	FINISH :	
.000 ± 0.075	±	SCALE : 3 : 1	
ANGLES ± 0.5		THIRD ANGLE PROJECTION	

FULL RISE ELECTRONIC CO., LTD

TITLE
11.5mm SIDE PCB JACK 6P

DRAWING NO. GE533022-LA SIZE A3 REV 0

/PART NO. SEE NOTE DO NOT SCALE DRAWING SHEET 1 OF 1